

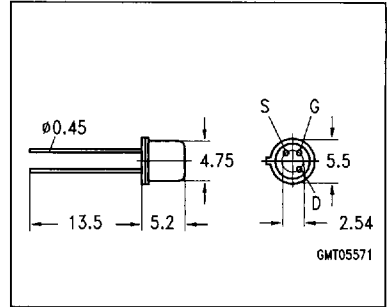
$$V_{DS} = 240 \text{ V}$$

$$I_D = 0.35 \text{ A}$$

$$R_{DS(on)} = 6.0 \Omega$$

- N channel
- Enhancement mode
- Package: TO-18¹⁾

Not for new design!



| Type | Ordering code for version in bulk |
|----------|-----------------------------------|
| ■ BSS 91 | Q 62702-S457 |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|---|----------------------|------------------|------------------|
| Drain-source voltage | V_{DS} | 240 | V |
| Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$ | V_{DGR} | 240 | |
| Gate-source voltage | V_{GS} | ± 14 | |
| Gate-source peak voltage, aperiodic | V_{gs} | ± 20 | |
| Continuous drain current, $T_C = 25 \text{ }^\circ\text{C}$ | I_D | 0.35 | A |
| Pulsed drain current, $T_C = 25 \text{ }^\circ\text{C}$ | $I_{D \text{ puls}}$ | 1.4 | |
| Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$ | P_{tot} | 1.5 | W |
| Operating and storage temperature range | T_j, T_{stg} | $-55 \dots +150$ | $^\circ\text{C}$ |
| Thermal resistance, chip-ambient (without heat sink), chip-case | R_{thJA} | ≤ 300 | K/W |
| | R_{thJC} | ≤ 83 | |
| DIN humidity category, DIN 40 040 | — | E | — |
| IEC climatic category, DIN IEC 68-1 | — | 55/150/56 | |

¹⁾ See chapter Package Outlines.

Electrical Characteristics

at $T_j = 25\text{ °C}$, unless otherwise specified.

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Static Characteristics

| | | | | | |
|---|---------------|-----|-----|------|---------------|
| Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25\text{ mA}$ | $V_{(BR)DSS}$ | 240 | – | – | V |
| Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$ | $V_{GS(th)}$ | 0.8 | 1.5 | 2.0 | |
| Zero gate voltage drain current $V_{DS} = 240\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$ | I_{DSS} | – | 0.1 | 1.0 | μA |
| | | – | 10 | 100 | |
| $V_{DS} = 60\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ | | – | – | 200 | nA |
| Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0$ | I_{GSS} | – | 10 | 100 | nA |
| Drain-source on-resistance $V_{GS} = 10\text{ V}, I_D = 0.35\text{ A}$ $V_{GS} = 4.5\text{ V}, I_D = 0.35\text{ A}$ | $R_{DS(on)}$ | – | 3.5 | 6.0 | Ω |
| | | – | 5.0 | 10.0 | |

Dynamic Characteristics

| | | | | | |
|--|--------------|------|------|-----|----|
| Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 0.35\text{ A}$ | g_{fs} | 0.14 | 0.37 | – | S |
| Input capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | C_{iss} | – | 115 | 155 | pF |
| Output capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | C_{oss} | – | 15 | 25 | |
| Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | C_{rss} | – | 8 | 12 | |
| Turn-on time t_{on} , ($t_{on} = t_{d(on)} + t_r$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.28\text{ A}$ | $t_{d(on)}$ | – | 6 | 9 | ns |
| | t_r | – | 10 | 15 | |
| Turn-off time t_{off} , ($t_{off} = t_{d(off)} + t_f$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.28\text{ A}$ | $t_{d(off)}$ | – | 33 | 45 | |
| | t_f | – | 22 | 30 | |

Electrical Characteristics (cont'd)

at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

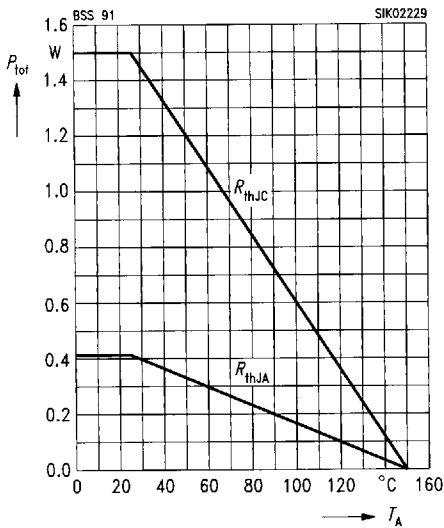
Reverse Diode

| | | | | | |
|--|----------|---|-----|------|---|
| Continuous reverse drain current $T_A = 25\text{ }^\circ\text{C}$ | I_S | — | — | 0.35 | A |
| Pulsed reverse drain current $T_A = 25\text{ }^\circ\text{C}$ | I_{SM} | — | — | 1.4 | |
| Diode forward on-voltage $I_F = 0.7\text{ A}$, $V_{GS} = 0$ | V_{SD} | — | 0.9 | 1.4 | V |

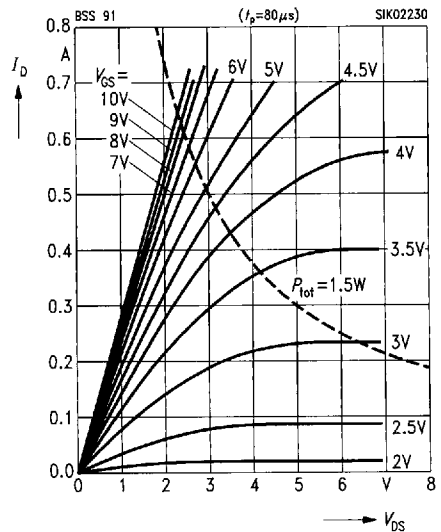
Characteristics

at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

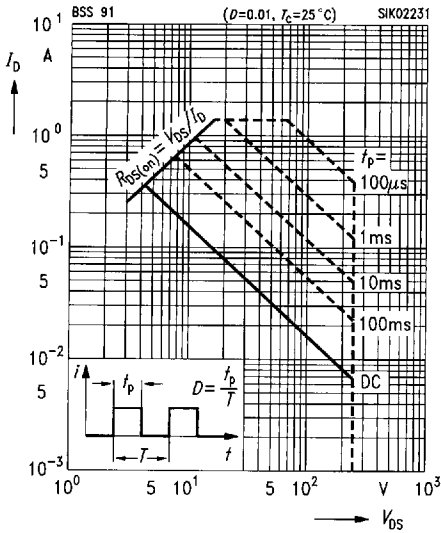
Total power dissipation $P_{tot} = f(T_A)$



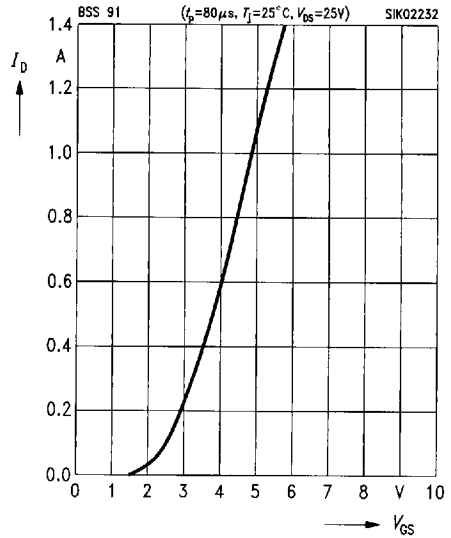
Typ. output characteristics $I_D = f(V_{DS})$
parameter: $t_p = 80\text{ }\mu\text{s}$



Safe operating area $I_D = f(V_{DS})$
 parameter: $D = 0.01, T_C = 25^\circ\text{C}$

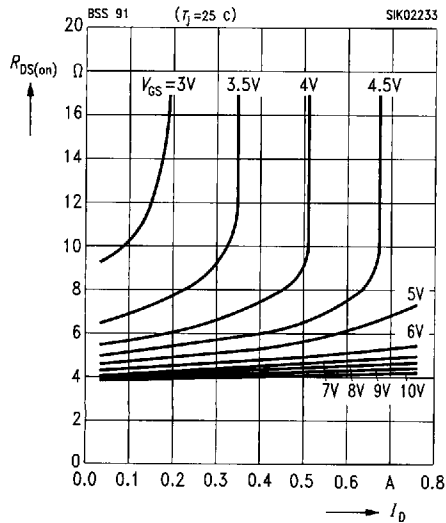


Typ. transfer characteristics $I_D = f(V_{GS})$
 parameter: $t_p = 80 \mu\text{s}, V_{DS} = 25 \text{ V}$



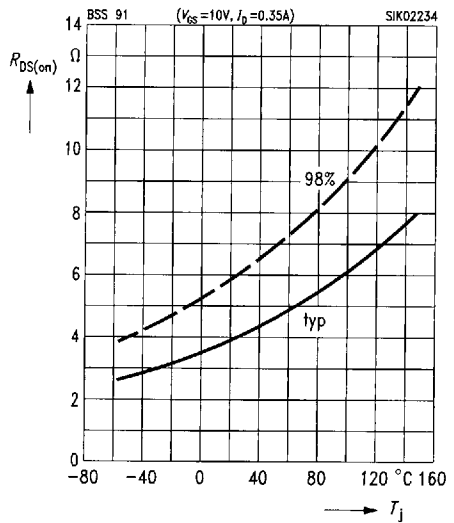
Typ. drain-source on-resistance

$R_{DS(on)} = f(I_D)$
 parameter: V_{GS}

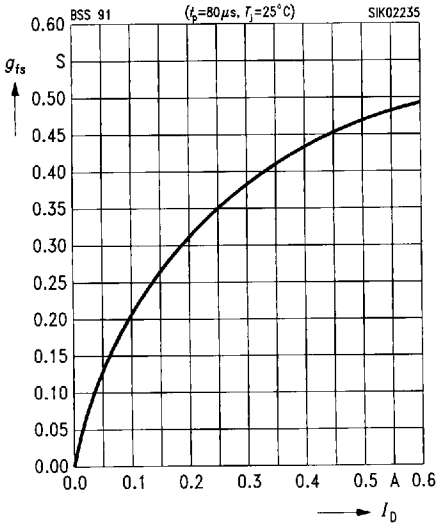


Drain-source on-resistance

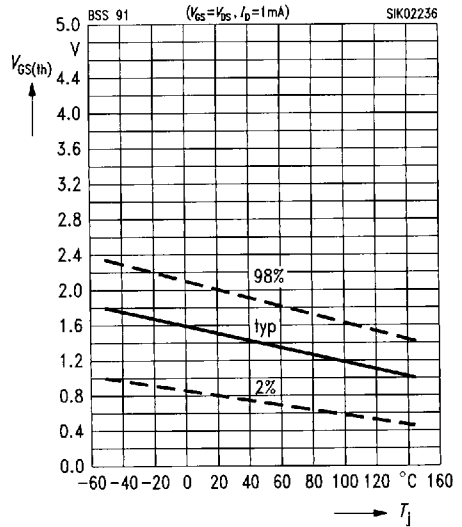
$R_{DS(on)} = f(T_j)$
 parameter: $I_D = 0.35 \text{ A}, V_{GS} = 10 \text{ V}, (\text{spread})$



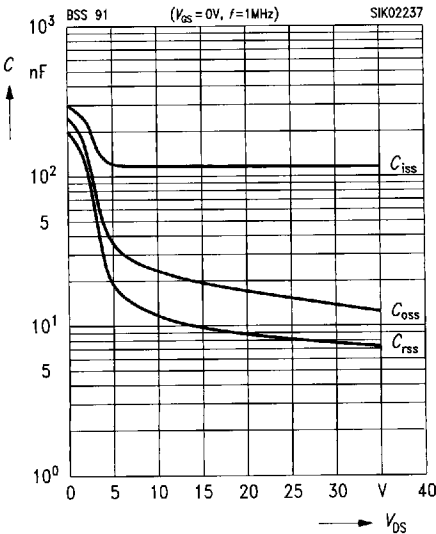
Typ. forward transconductance $g_{fs} = f(I_D)$
 parameter: $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$, $t_p = 80 \mu s$



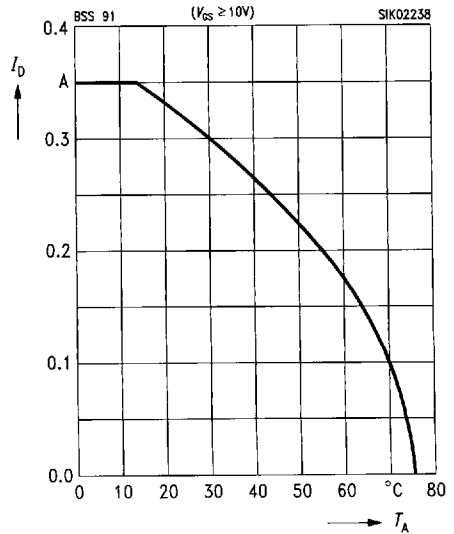
Gate threshold voltage $V_{GS(th)} = f(T_j)$
 parameter: $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$, (spread)



Typ. capacitances $C = f(V_{DS})$
 parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



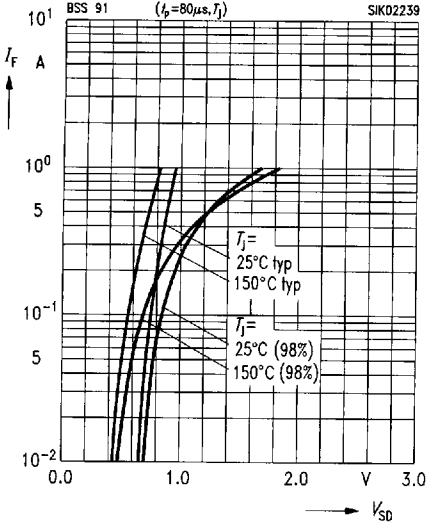
Drain current $I_D = f(T_A)$
 parameter: $V_{GS} \geq 10 \text{ V}$



Forward characteristics of reverse diode

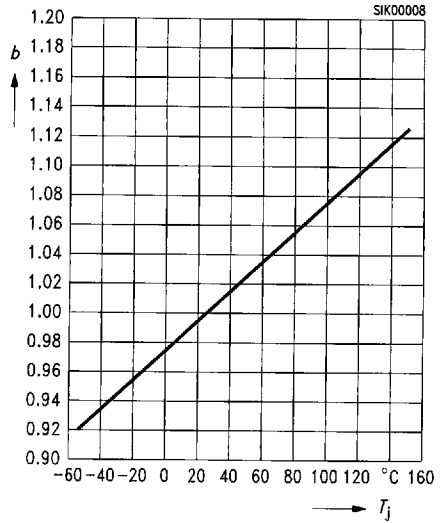
$I_F = f(V_{SD})$

parameter: $t_p = 80 \mu s, T_j, (\text{spread})$



Drain-source breakdown voltage

$V_{(BR)DSS} = b \times V_{(BR)DSS}(25^\circ\text{C})$



This datasheet has been downloaded from:

www.DatasheetCatalog.com

Datasheets for electronic components.